The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

GreenMOS®

RoHS compliant

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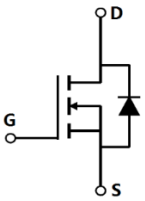
Parameter	Value	Unit
$V_{DS,\ min}$ @ $T_{j(max)}$	750	V
$I_{D,\ pulse}$	33	A
$R_{DS(ON)\ ,\ max}$ @ V_{GS}=10V	360	
Q_g	13.3	nC

Product Name	Package	Marking
OSG70R360DTF	TO252	OSG70R360DT



Absolute Maximum Ratings at T_j=25 unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	700	V
Gate-source voltage	V_{GS}	±30	V
Continuous drain current[1], T_C=25 °C	I_D	11	A
Continuous drain current[1], T_C=100 °C		7	
Pulsed drain current[2], T_C=25 °C	$I_{D, pulse}$	33	A
Continuous diode forward current[1], T_C=25 °C	I_S	11	A
Diode pulsed current[2], T_C=25 °C	$I_{S, pulse}$	33	A
Power dissipation[3], T_C=25 °C	P_D	63	W
Single pulsed avalanche energy[5]	E_{AS}	150	mJ
MOSFET dv/dt ruggedness, V_{DS} 480 V	dv/dt	50	V/ns
Reverse diode dv/dt, V_{DS} 480 V, I_{SD} D	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	R	2	°C/W
Thermal resistance, junction-ambient[4]	R	62	°C/W

Electrical Characteristics at T_j=25 unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	700			V	V_{GS}=0 V, I_D=250 A
		750				V_{GS}=0 V, I_D=250 A, T_j=150 °C
Gate threshold voltage	$V_{GS(th)}$	2.9		3.9	V	V_{DS}=V_{GS}, I_D=250 A
Drain-source on-state resistance	$R_{DS(ON)}$		0.32	0.36		V_{GS}=10 V, I_D=3 A
			0.78			V_{GS}=10 V, I_D=3 A, T_j=150 °C
Gate-source leakage current	I_{GSS}			100	nA	V_{GS}=30 V
				-100		V_{GS}=-30 V
Drain-source leakage current	I_{DSS}			1	A	V_{DS}=700 V, V_{GS}=0 V

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}				pF	V_{GS}=0 V, V_{DS}=50 V, 00 kHz
Output capacitance	C_{oss}		62.7		pF	
Reverse transfer capacitance	C_{rss}		2.2		pF	
Turn-on delay time	$t_{d(on)}$		30.7		ns	V_{GS}=10 V, V_{DS}=400 V, R_G) I_D=6 A
Rise time	t_r		33.9		ns	
Turn-off delay time	$t_{d(off)}$					

Electrical Characteristics Diagrams

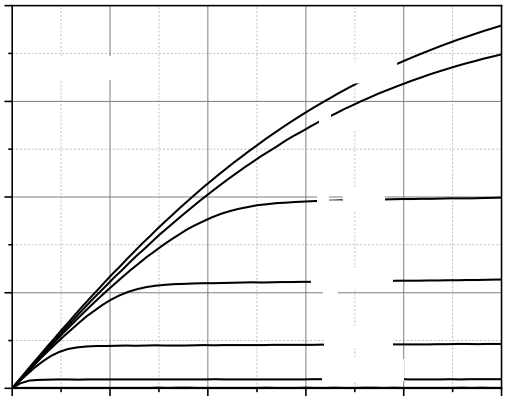


Figure 1. Typ. output characteristics

Figure 2. Typ. transfer characteristics

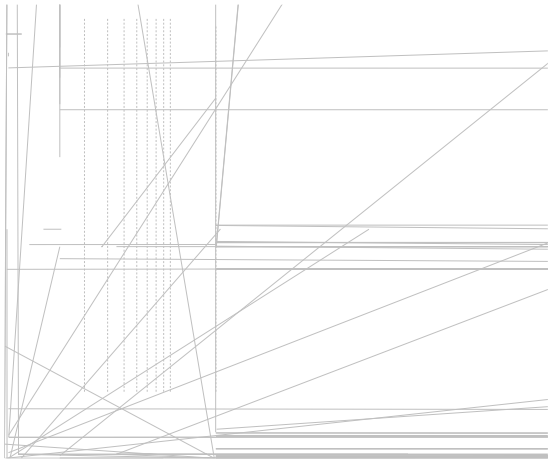


Figure 3. Typ. capacitances

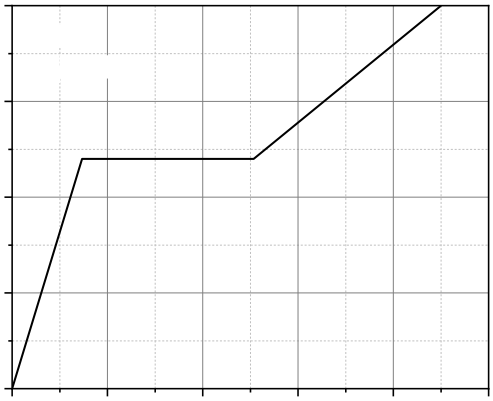


Figure 4. Typ. gate charge

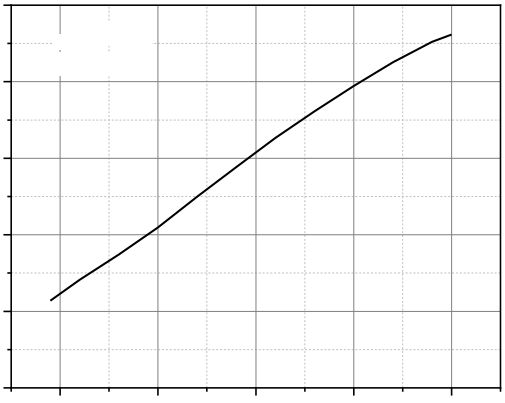


Figure 5. Drain-source breakdown voltage

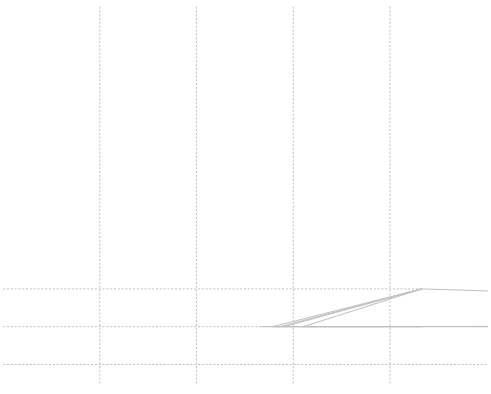


Figure 6. Drain-source on-state resistance

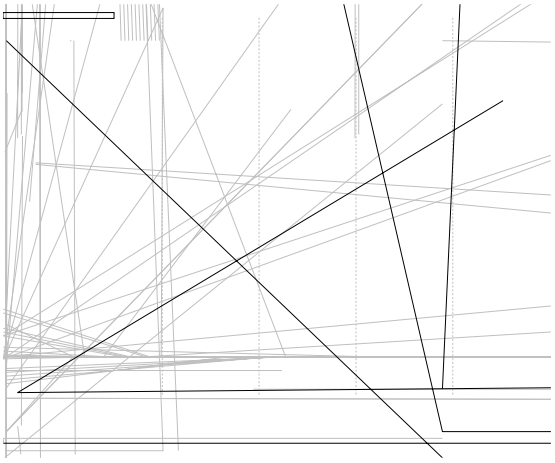


Figure 7. Threshold voltage

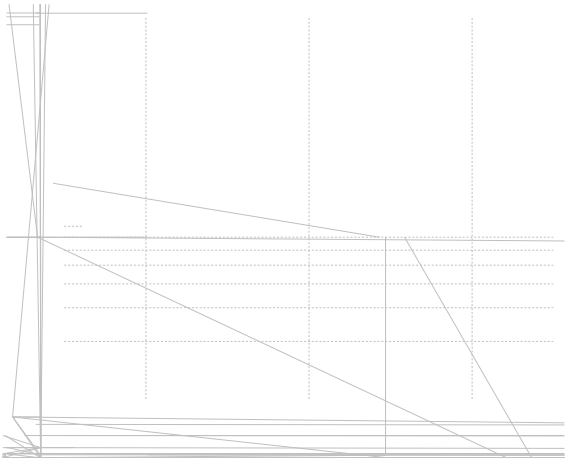


Figure 8. Forward characteristic of body diode

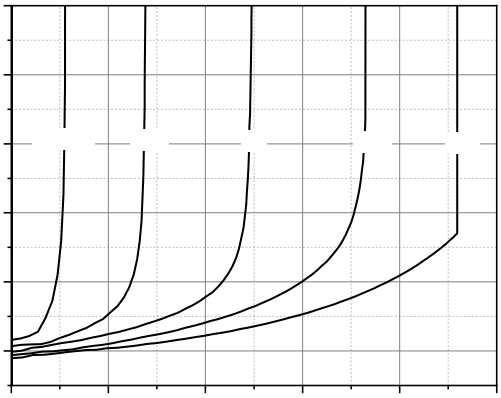


Figure 9. Drain-source on-state resistance

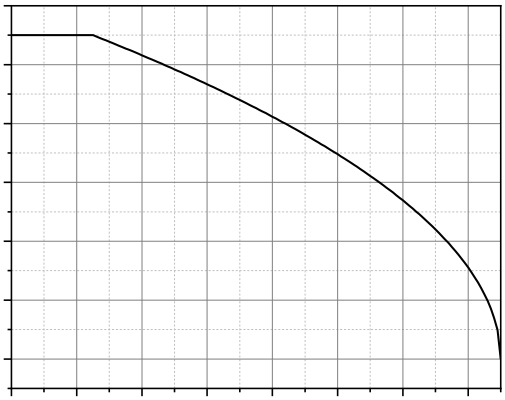


Figure 10. Drain current

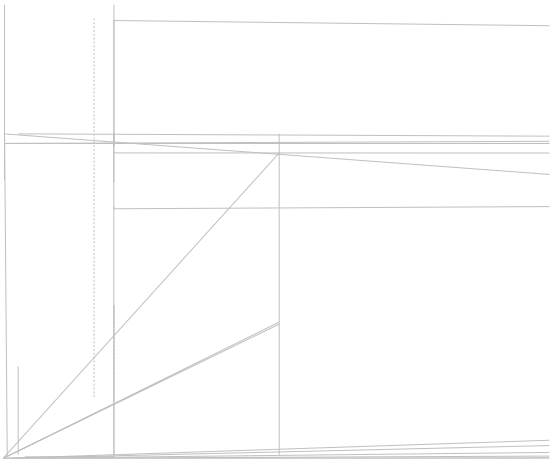


Figure 11. Safe operation area T_C=25 °C

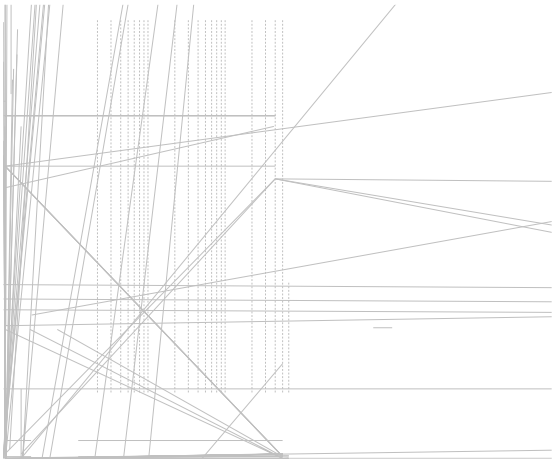
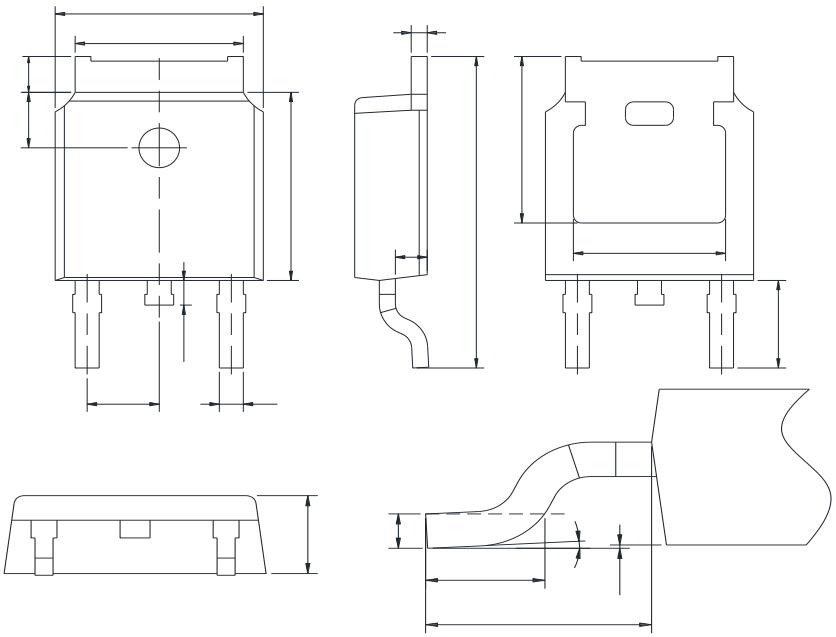


Figure 12. Max. transient thermal impedance

Package Information



Symbol	mm		
	Min	Nom	Max
A	2.20	2.30	2.38
A1	0.00	-	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1	5.30REF		
E	6.40	6.60	6.73
E1	4.63	-	-
e	2.286BSC		
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1	2.90REF		
L2	0.51BSC		
L3	0.88	-	1.28
L4	0.50	-	1.00
	0	-	

Version 1: TO252-C package outline dimension

Ordering Information

Package Type	Units/ Reel	Reels/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO252-C	2500	2	5000	5	25000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG70R360DTF	TO252	yes	yes	yes

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